

| Ref # | Hits | Search Query  | DBs   | Default Operator | Plurals | Time Stamp       |
|-------|------|---|---|------------------|---------|------------------|
| L1    | 108  | 216/13-18.ccls. and (solder adj mask)   | US-PGPUB;<br>USPAT;<br>USOCR;<br>EPO; JPO;<br>DERWENT | OR               | ON      | 2005/03/28 08:55 |
| L2    | 106  | 216/13-18.ccls. and (solder adj mask) and (board or substrate)                            | US-PGPUB;<br>USPAT;<br>USOCR;<br>EPO; JPO;<br>DERWENT | OR               | ON      | 2005/03/28 08:56 |
| L3    | 90   | 216/13-18.ccls. and (solder adj mask) and (board or substrate) and (conductor or pattern) | US-PGPUB;<br>USPAT;<br>USOCR;<br>EPO; JPO;<br>DERWENT | OR               | ON      | 2005/03/28 08:56 |
| L4    | 131  | 29/847-853.ccls. and (solder adj mask)  | US-PGPUB;<br>USPAT;<br>USOCR;<br>EPO; JPO;<br>DERWENT | OR               | ON      | 2005/03/28 08:56 |
| L5    | 134  | 174/255-256.ccls. and (solder adj mask)   | US-PGPUB;<br>USPAT;<br>USOCR;<br>EPO; JPO;<br>DERWENT | OR               | ON      | 2005/03/28 08:57 |
| L6    | 305  | 174/260-264.ccls. and (solder adj mask)   | US-PGPUB;<br>USPAT;<br>USOCR;<br>EPO; JPO;<br>DERWENT | OR               | ON      | 2005/03/28 08:57 |
| L7    | 57   | 361/792-795.ccls. and (solder adj mask)   | US-PGPUB;<br>USPAT;<br>USOCR;<br>EPO; JPO;<br>DERWENT | OR               | ON      | 2005/03/28 08:59 |
| L8    | 16   | 2 and (CTE or coefficient)  | US-PGPUB;<br>USPAT;<br>USOCR;<br>EPO; JPO;<br>DERWENT | OR               | ON      | 2005/03/28 08:58 |
| L9    | 59   | 428/209-210.ccls. and (solder adj mask)   | US-PGPUB;<br>USPAT;<br>USOCR;<br>EPO; JPO;<br>DERWENT | OR               | ON      | 2005/03/28 08:59 |